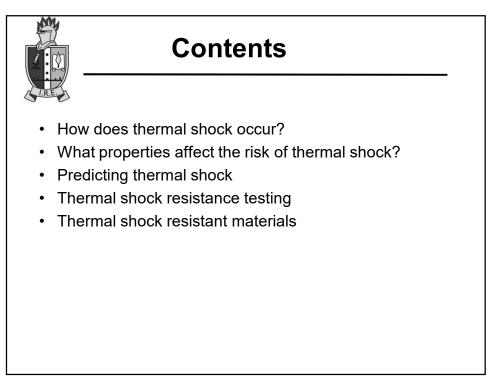


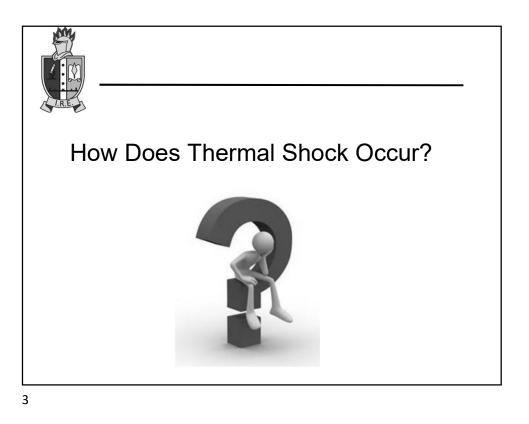
Institute of Refractories Engineers

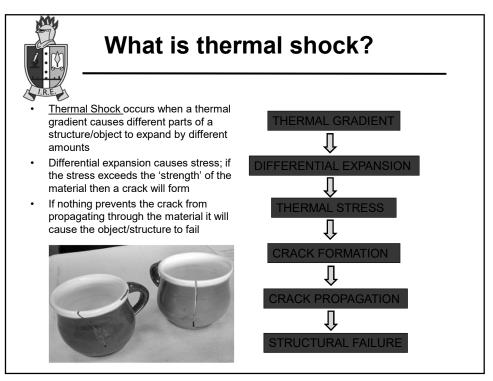
Material Properties & Thermal Shock Parameters

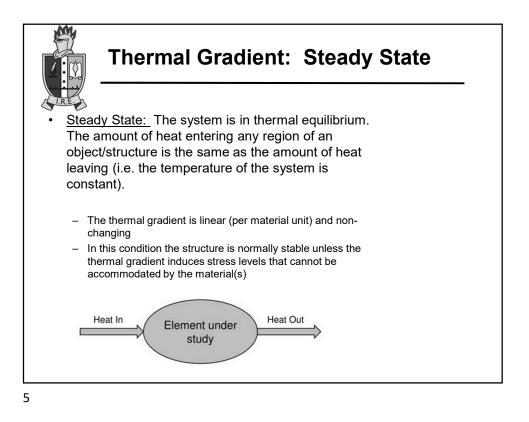
Training Day 2019

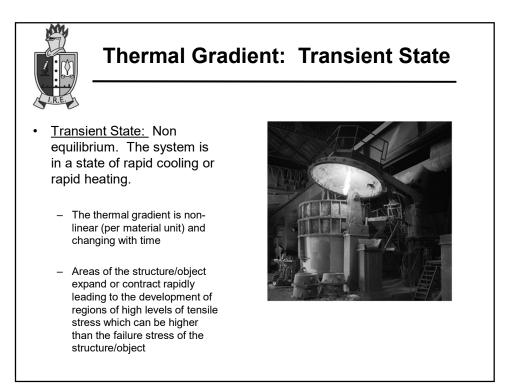
M Frith Sheffield November 2019

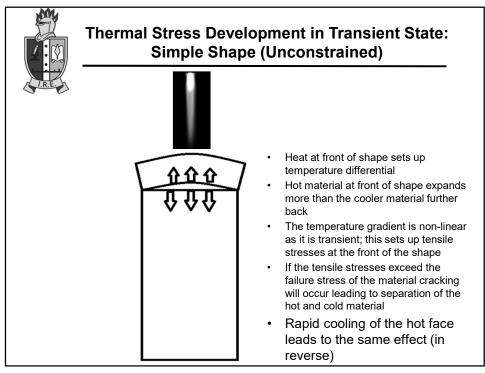


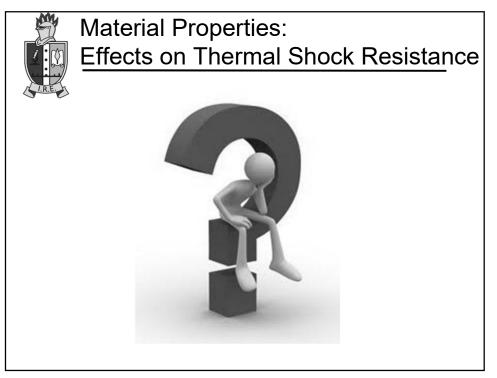


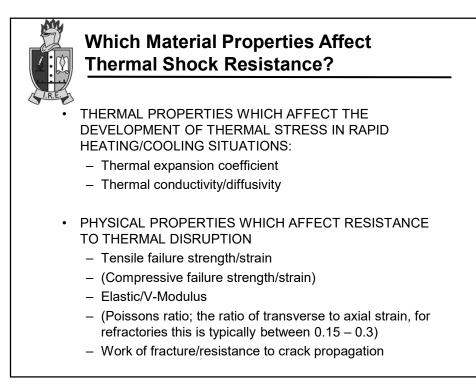


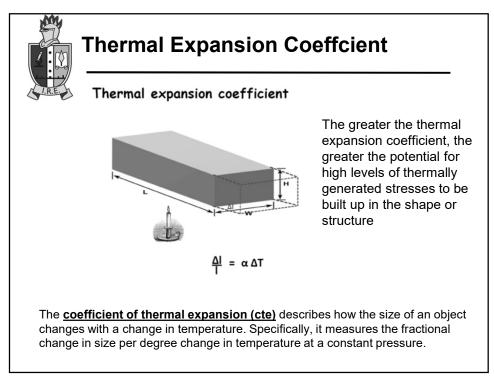


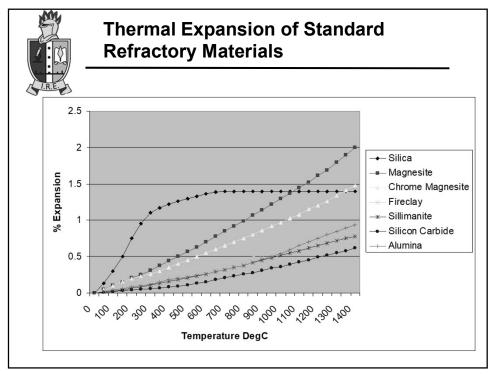


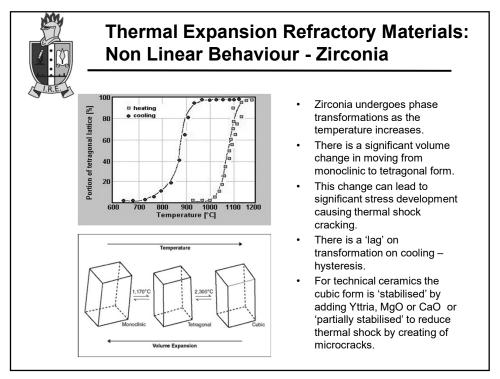








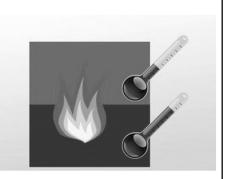


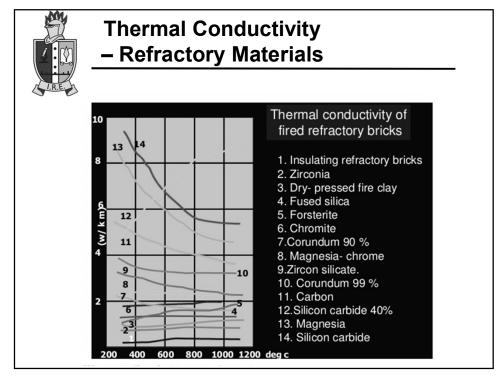




Thermal Conductivity

- The thermal conductivity of a material is a measure of its ability to conduct heat.
- Heat transfer occurs at a lower rate in materials of low thermal conductivity than materials of high thermal conductivity.
- Relationship to thermal stress development:
 - Higher thermal conductivity materials more rapidly dissipate transient localised thermal differences and therefore mitigate differential thermal expansions and resultant thermal stress development.

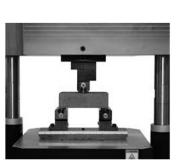


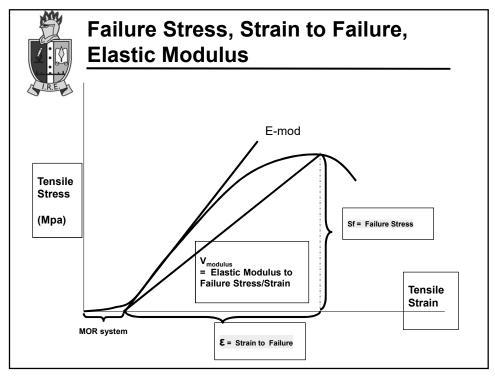


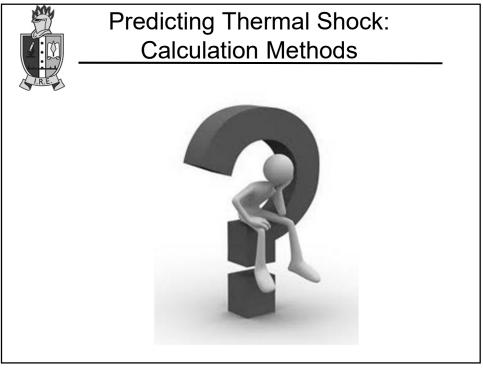
Failure Stress, Strain to Failure, Elastic Modulus

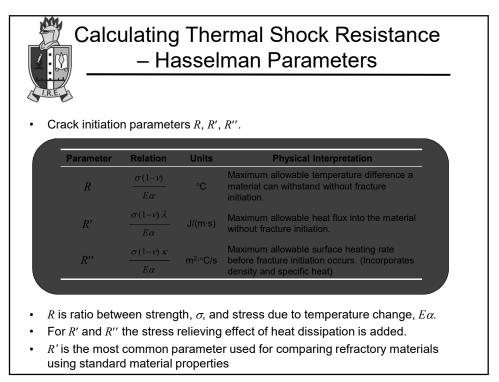
Physical properties important for thermal shock resistance:

- Failure Stress: Tensile failure stress determines the amount of stress the material can withstand before disruption. Normally measured via modulus/hot modulus of rupture testing. For thermal shock resistance high is good.
- Failure Strain: The level of deformation (extension in a tensile test) the material can accommodate before breakage. For thermal shock resistance high is good.
- Elastic modulus: V modulus, Youngs Modulus, essentially a measure of the flexibility of the material (Stress/Strain ratio). For thermal shock resistance low is good (high flexibility)









Comparison of 2 Materials A & B										
			Materials			(Materials		
Material Properties		Α		В		Hassel	man Parameters	А	В	
λ	J/(m·s·°C)	3.0	ł	2.5		R	°C	189	100	
C_p	J/(kg·°C)	1000	ŧ	1100		R'	J/(m·s)	567	250	
ρ	kg/m³	2500	•	2750		$R^{\prime\prime}$	10 ⁻⁴ m ^{2.} ℃/s	2.3	0.8	
α	10 ^{–6} °C ^{−1}	5.0	ŧ	8.0						
Ε	10 ⁹ Pa	5.5	¥	6.0						
σ_t	10 ⁶ Pa	6.5	4	6.0						
\mathcal{E}_{t}	10 ⁻³	1.2		1.0						
$\sigma_{\!c}$	10 ⁶ Pa	35.0		30.0	Ν	Material A is much more thermal show				
ε _c	10 ⁻³	6.4		5.0		resistant than material B				
v	-	0.2		0.2			says Hass	elman		
$\kappa = \lambda$	$/(C_p \rho) \downarrow$									

